

Electronic Patent Application Fee Transmittal

Application Number:	10798540			
Filing Date:	10-Mar-2004			
Title of Invention:	Attachment of integrated circuit structures and other substrates to substrates with vias			
First Named Inventor/Applicant Name:	Sergey Savastiouk			
Filer:	Michael Shenker/Jeannie Ha			
Attorney Docket Number:	M-15302-1P US			
Filed as Large Entity				
Utility Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Submission- Information Disclosure Stmt	1806	1	180	180
Total in USD (\$)				180